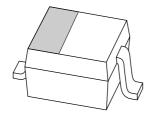
# **DISCRETE SEMICONDUCTORS**

# DATA SHEET



# **BA591**Band-switching diode

Product specification Supersedes data of 1998 Aug 31 2004 Feb 17





# **Band-switching diode**

**BA591** 

# **FEATURES**

- · Very small plastic SMD package
- Low diode capacitance: max. 1.05 pF
- Low diode forward resistance: max. 0.7  $\Omega$
- · Small inductance.

# **APPLICATIONS**

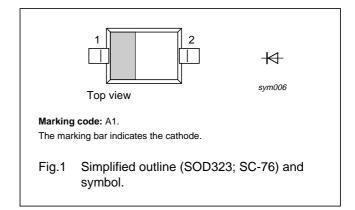
- Low loss band-switching in VHF television tuners
- Surface mount band-switching circuits.

# **DESCRIPTION**

The BA591 is a planar, high performance band-switching diode in the very small SOD323 (SC-76) SMD plastic package.

### **PINNING**

PIN	DESCRIPTION
1	cathode
2	anode



# **ORDERING INFORMATION**

TYPE		PACKAGE					
NUMBER NAME DE		DESCRIPTION	VERSION				
BA591	_	plastic surface mounted package; 2 leads SOE					

# LIMITING VALUES

In accordance with the Absolute Maximum Rating System (IEC 60134).

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
$V_R$	continuous reverse voltage		_	35	V
I <sub>F</sub>	continuous forward current		_	100	mA
P <sub>tot</sub>	total power dissipation	T <sub>s</sub> = 90 °C	_	500	mW
T <sub>stg</sub>	storage temperature		-65	+150	°C
Tj	junction temperature		-65	+150	°C

Philips Semiconductors Product specification

# Band-switching diode

**BA591** 

# **CHARACTERISTICS**

 $T_j$  = 25 °C unless otherwise specified.

SYMBOL	PARAMETER	CONDITIONS	TYP.	MAX.	UNIT
V <sub>F</sub>	forward voltage	I <sub>F</sub> = 10 mA	_	1	V
I <sub>R</sub>	reverse current	V <sub>R</sub> = 20 V	_	20	nA
C <sub>d</sub>	diode capacitance	f = 1 MHz; note 1; see Fig.2			
		V <sub>R</sub> = 1 V	0.8	1.05	pF
		V <sub>R</sub> = 3 V	0.65	0.9	pF
$r_D$	diode forward resistance	f = 100 MHz; note 1; see Fig.3			
		$I_F = 3 \text{ mA}$	0.45	0.7	Ω
		I <sub>F</sub> = 10 mA	0.36	0.5	Ω
1/g <sub>p</sub>	reverse resistance	V <sub>R</sub> = 1 V; f = 100 MHz; note 1	100	_	kΩ
L <sub>S</sub>	series inductance		2	_	nH

# Note

# THERMAL CHARACTERISTICS

SYMBOL	PARAMETER	VALUE	UNIT
R <sub>th(j-s)</sub>	thermal resistance from junction to soldering point	120	K/W

<sup>1.</sup> Guaranteed on AQL basis; inspection level S4, AQL 1.0.

Philips Semiconductors Product specification

# Band-switching diode

**BA591** 

# **GRAPHICAL DATA**

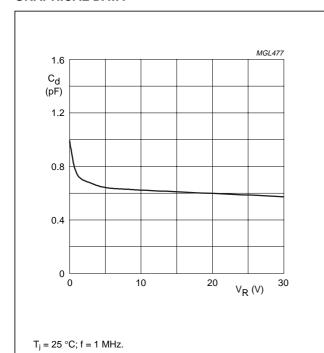


Fig.2 Diode capacitance as a function of reverse voltage; typical values.

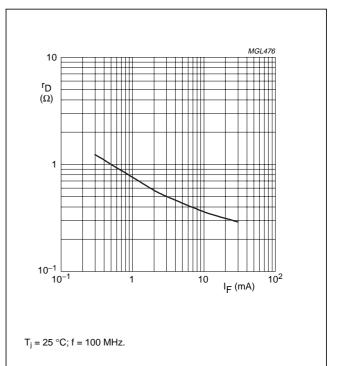


Fig.3 Diode forward resistance as a function of forward current; typical values.

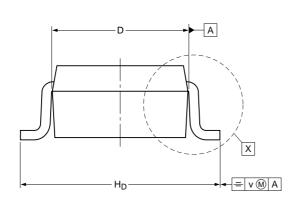
# Band-switching diode

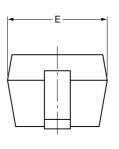
**BA591** 

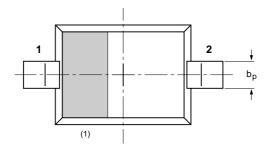
# **PACKAGE OUTLINE**

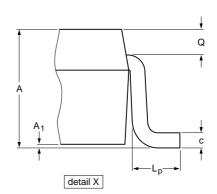
Plastic surface mounted package; 2 leads

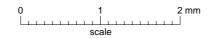
SOD323











# DIMENSIONS (mm are the original dimensions)

UNIT	Α	A <sub>1</sub> max	bp	С	D	E	H <sub>D</sub>	Lp	Q	v
mm	1.1 0.8	0.05	0.40 0.25	0.25 0.10	1.8 1.6	1.35 1.15	2.7 2.3	0.45 0.15		0.2

### Note

1. The marking bar indicates the cathode

OUTLINE	OUTLINE REFERENCES				EUROPEAN	ISSUE DATE
VERSION	IEC	JEDEC	JEITA		PROJECTION	ISSUE DATE
SOD323			SC-76			<del>99-09-13</del> 03-12-17

Philips Semiconductors Product specification

# Band-switching diode

**BA591** 

# **DATA SHEET STATUS**

LEVEL	DATA SHEET STATUS <sup>(1)</sup>	PRODUCT STATUS(2)(3)	DEFINITION
I	Objective data	Development	This data sheet contains data from the objective specification for product development. Philips Semiconductors reserves the right to change the specification in any manner without notice.
II	Preliminary data	Qualification	This data sheet contains data from the preliminary specification. Supplementary data will be published at a later date. Philips Semiconductors reserves the right to change the specification without notice, in order to improve the design and supply the best possible product.
III	Product data	Production	This data sheet contains data from the product specification. Philips Semiconductors reserves the right to make changes at any time in order to improve the design, manufacturing and supply. Relevant changes will be communicated via a Customer Product/Process Change Notification (CPCN).

### **Notes**

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- 2. The product status of the device(s) described in this data sheet may have changed since this data sheet was published. The latest information is available on the Internet at URL http://www.semiconductors.philips.com.
- 3. For data sheets describing multiple type numbers, the highest-level product status determines the data sheet status.

# **DEFINITIONS**

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Limiting values definition — Limiting values given are in accordance with the Absolute Maximum Rating System (IEC 60134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of the specification is not implied. Exposure to limiting values for extended periods may affect device reliability.

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